



# SPECIFICATION FOR LVDS OUTPUT SMT VCXO MtronPTI P/N M3100S095

### **Electrical Specifications:**

Parameter	Symbol	Min.	Тур.	Max.	Units	Conditions
Operating Frequency	Fo		100.000000		MHz	V <sub>C</sub> =1.65 V @ +25°C
Frequency Stability		-30		+30	ppm	Over operating temperature
Operating Temperature	TA	0		+70	°C	
Storage Temperature	Ts	-55		+125	°C	
Aging		-3		+3	ppm	1 <sup>st</sup> year
Aging		-1		+1	ppm	Thereafter (per year)
Operating Voltage	Vcc	3.135	3.3	3.465	V	
Operating Current	lcc			125	mA	
Output Type		Differential LVDS Compatible				
Output Load		100 Ω Differential			V	
Symmetry (duty cycle)	T <sub>W</sub> /t	45		55	%	@ 1.25 V
Common Mode Output Voltage	Vсм		1.2		V	100 $\Omega$ Differential load
Differential Output Voltage	Vod	250	350	450	mV	100 $\Omega$ Differential load
Rise/Fall Time	t <sub>R</sub> /t <sub>F</sub>			0.5	nS	From 20% to 80% of Waveform
Start-up Time	Ts∪			10	mS	
Control Voltage	Vc	0.3	1.65	3.0	V	Pad 1. Vcc = 3.3 V
Pullability		± 150			ppm	
Linearity				+5	%	Positive slope
Modulation Bandwidth	BW	10			kHz	- 3 dB V <sub>C</sub> = 1.65 V
Input Impedance	Zvc	50			kΩ	Pad 1
Phase Jitter (RMS)				1.0	pS	12 kHz to 20 MHz
Enable Function		80% V <sub>CC</sub> or N/C				Pad 2
Disable Function				0.5 V		Pad 2

#### **Environmental & Packaging Requirements:**

Mechanical Shock	Per MIL-STD-202, Method 213, Condition C (100 g's, 6 ms duration, ½ sinewave)
Vibration	Per MIL-STD-202, Method 201 & 204 (10 g's from 10-2000 Hz)
Thermal Cycle	Per MIL-STD-883, Method 1010, B (-55°C to 125°C, 15 min. dwell, 10 cycles)
Hermeticity	Per MIL-STD-202, Method 112 (1 x 10 <sup>-8</sup> atm cc/s of Helium)
Solderability	Per EIAJ-STD-002
Max. Soldering Conditions	See solder profile, Figure 1.
Package Type	5.0 X 7.0 X 2.0 mm 6-pad leadless ceramic. RoHS compliant.





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## Mechanical, Marking, and Pin-Out Information:

Pad	Function	[	Par	t Marking			
1	Control Voltage		Line 1	M3100S095			Legend
2	Enable/Disable		Line2	100M0000		уу	Year
3	Ground		Line 3	MPTI (yyww)		ww	Work Week
4	CLK +						
5	CLK -						
6	Supply +V <sub>cc</sub>						
	0.276 ±0.008 (7.00 ±0.20) 6 5 4 Line 1 Line 2 Line 3 1 2 3 75 (1.90) MAX	Pad 1	0.200 (5.08) TYP 	0.055 (1.40) TYP	0.102 - (2.60) TYP .01µFd		ED SOLDER PAD LAYOUT 0.200 (5.08) (5.08) (1.80) (1.80) (1.80) (1.80) (4.20) (4.20) (4.20) (5.09) (4.20) (4.20) All dimensions in inches (mm)
	260°C - 150°C - 150°C -		3°C	•		ZONE	L TEMPERATURE • RAMP-DOWN 6°C/SECOND • 90 SECONDS MAX. FOR 10 SECONDS MAX.

#### DATA SHEET REVISION TABLE:

Date	Rev.	Author	Details of Revision
06/07/12	0	LEO	Original release.
9/20/12	Α	MM	Corrected APR to PULL